

06-08-2006



FORM PTO-1595

(Rev. 10/02)

Docket No.: 069576-0080

103253354  
PATENTS ONLY

3T

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

6.2.06

To the Honorable Commissioner for Patents and Trademarks: Please record the attached original documents or copy thereto:

## 1. Name of Conveying Party(ies):

Seon Goo LEE, Hun Joo HAHM, Jung Kyu PARK, Kyung Taeg HAN, Seong Yeon HAN, Dae Yeon KIM, Young Sam PARK

Additional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

## 3. Nature of Conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other

Execution Date: May 23, 2006

## 2. Name and address of receiving party(ies):

Name: SAMSUNG ELECTRO-MECHANICS CO., LTD

Address: 314 Maetan 3-dong, Youngtong-ku  
Suwon  
Kyungki-do, Republic of KoreaAdditional name(s) & address(es) attached? ☐ Yes ☐ No113211 U.S. PTO  
11/445227  
060206

## 4. Application number(s) or patent number(s):

If the document is being filed together with a new application, the execution date of the application is: May 23, 2006

A. Patent Application No(s).

B. Patent No(s).

Additional numbers attached? ☐ Yes ☐ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Name: MCDERMOTT WILL &amp; EMERY LLP

Internal Address:

Street Address: 600 13th Street, N.W.

City: Washington State: D. C. Zip: 20005-3096

## 6. Total number of applications and patents involved:

7. Total fee (37 CFR 3.41)

\$40.00

☐ Enclosed☒ Authorized to be charged to deposit account

## 8. Deposit account number:

500417

1145227

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## 9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

Stephen A. Becker, Registration No. 26,527

Name and Registration No. of Person Signing

  
Signature

June 2, 2006

Date

Total number of pages including cover sheet:

3

OMB No. 0651-0027 (exp. 6/30/2005)

1145227  
500417  
06/07/2006  
01 FC:0021

PATENT

REEL: 017953 FRAME: 0272

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) <u>Seon Goo LEE</u>	(5) <u>Seong Yeon HAN</u>
(2) <u>Hun Joo HAHM</u>	(6) <u>Dae Yeon KIM</u>
(3) <u>Jung Kyu PARK</u>	(7) <u>Young Sam PARK</u>
(4) <u>Kyung Taeg HAN</u>	(8) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto

SAMSUNG ELECTRO-MECHANICS CO., LTD.

314 Maetan-3-dong, Youngtong-ku, Suwon, Kyungki-do, Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

HIGH POWER LED PACKAGE AND FABRICATION METHOD THEREOF

(a) for which an application for United States Letters Patent was filed on \_\_\_\_\_, and identified by United States Serial No. \_\_\_\_\_; or

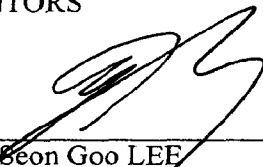
(b) for which an application for United States Letters Patent was executed on \_\_\_\_\_, and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;


AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

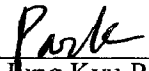
SIGNED on the dates indicated aside our signatures:

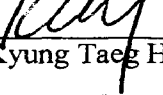
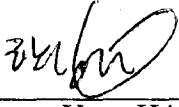


INVENTORS

DATE SIGNED

1)  \_\_\_\_\_  
Name: Seon Goo LEE May 23, 2006

2)  \_\_\_\_\_  
Name: Hun Joo HAHM May 23, 2006

3)  \_\_\_\_\_  
Name: Jung Kyu PARK May 23, 2006

- 4)   
Name: Kyung Taeg HAN May 23, 2006
- 5)   
Name: Seong Yeon HAN May 23, 2006
- 6)   
Name: Dae Yeon KIM May 23, 2006
- 7)   
Name: Young Sam PARK May 23, 2006